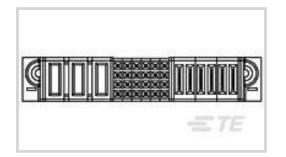


MULTI-BEAM | MULTI-BEAM XLE

TE Internal #: 6450850-3 PCB Mount Receptacle, Vertical, Board-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), MULTI-BEAM XLE View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 26

Number of Rows: **4**

Features

Product Type Features

Mixed & Hybrid Header	Yes
Connector Shape	Rectangular
PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board

Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Number of Columns	8
Number of Loaded Positions	26
Mating & Unmating Configuration	Normal
Number of Signal Positions	24
Number of Power Positions	2
PCB Mount Orientation	Vertical
Number of Positions	26
Number of Rows	4
Electrical Characteristics	
Operating Voltage	60 VDC

PCB Mount Receptacle, Vertical, Board-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), MULTI-BEAM XLE



Body Features

Primary Product Color	Black
Contact Features	
Contact Underplating Material	Nickel
Contact Underplating Material Thickness	1.27 – 2.54 μm[50 – 100 μin]
Contact Mating Area Plating Material Thickness	.076 μm[3 μin]
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Layout	Matrix
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Receptacle
Contact Current Rating (Max)	42 A
Termination Features	
Termination Post & Tail Length	3.43 mm[.135 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

Mating Retention	Without
Mating Alignment Type	Guide Post
PCB Mount Retention Type	Hold-Down
PCB Mount Alignment Type	Hold-Down
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Mating Alignment	With
Housing Features	
Housing Features Housing Material	High Temperature Thermoplastic Glass- Filled
Housing Material	Filled
Housing Material Centerline (Pitch)	Filled
Housing Material Centerline (Pitch) Dimensions	Filled 2.54 mm[.1 in]

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PCP Thickness (Pasammandad)	2.11 - 2.62 mm[0.002 - 1.02 in]
PCB Thickness (Recommended)	2.11 – 2.62 mm[.083 – .103 in]
Connector Height	12.7 mm[.5 in]
Connector Length	39.12 mm[1.54 in]
Usage Conditions	
Operating Temperature (Max)	105 °C[221 °F]
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Circuit Application Industry Standards	Power & Signal
	Power & Signal High Temperature Part - Not Glow Wire
Industry Standards	
Industry Standards Glow Wire Rating	High Temperature Part - Not Glow Wire
Industry Standards Glow Wire Rating UL Flammability Rating	High Temperature Part - Not Glow Wire

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent to these limits as defined in the Annexes of Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

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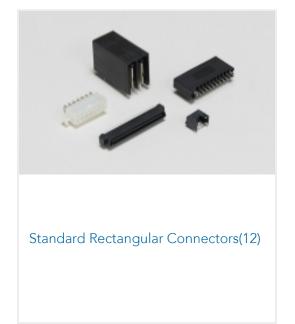
as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series MULTI-BEAM XLE





Customers Also Bought



Documents

PCB Mount Receptacle, Vertical, Board-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), MULTI-BEAM XLE



Product Drawings MBXLE VERT RCPT 1P + 24S + 1P English CAD Files 3D PDF 3D Customer View Model ENG_CVM_CVM_6450850-3_B3.2d_dxf.zip English Customer View Model ENG_CVM_CVM_6450850-3_B3.3d_igs.zip English

Customer View Model

ENG_CVM_CVM_6450850-3_B3.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages POWER_CONNECTORS_CATALOG_SEC01_BOARD_TO_BOARD

English

2_PIECE_POWER_CONNECTORS_qrg_4-1773458-1

English

Product Specifications

Application Specification

English